

C250 Series

Features

- Radial Leaded Devices
- Cured, flame retardant epoxy polymer insulating material meets
 UL 94V-0 requirements
- Bulk packaging, or tape and reel available on most models

Applications

Almost anywhere there is a low voltage power supply, up to DC60V and a load to be protected, including:

- Security and fire alarm systems
- Analog and digital line cards
- Modems and DSL

Alpha-Top (Sea & Land Alliance)

Electrical Properties

	I _{hold} Itrip		V _{max} V _{max} Operating Interrupt		I _{max}	P_d	Maximum Time To Trip		Resistance			Agency
Model	(A)	(A)	(Vdc)	(Vrms)	(A)	Typ.	Current	Time	Ri _{min.}	Ri _{max.}	$R1_{max}$	Approval
						(W)	(A)	(Sec)	(Ω)	(Ω)	(Ω)	UL
C250-080	0.080	0.160	60	250	3.0	1.00	0.35	3.00	12.0	22.0	33.0	√
C250-110	0.110	0.220	60	250	3.0	1.00	1.00	1.10	6.0	12.0	16.0	√
C250-120	0.120	0.240	60	250	3.0	1.00	1.00	1.50	6.5	10.5	16.0	√
C250-145	0.145	0.290	60	250	3.0	1.00	1.00	2.50	3.5	6.5	14.0	√
C250-180	0.180	0.360	60	250	10.0	1.50	1.00	18.00	1.0	3.0	5.0	√

Ihold = Hold Current. Maximum current device will not trip in 25°C still air.

Itrip = Trip Current. Minimum current at which the device will always trip in 25°C still air.

Vmax Operating = Maximum operating voltage (Vdc) device can withstand without damage at rated current (Imax).

Vmax Interrupt = Maximum interrupt voltage(Vac) device can withstand without damage at rated current (I2t = 1A2S).

Imax = Maximum fault current device can withstand without damage at rated voltage (Vmax).

Pd = Typical power dissipated from device when in the tripped state in 25°C still air environment at rated voltage.

Rimin/max = Minimum/Maximum device resistance prior to tripping at 25°C

R1max = Maximum device resistance one hour after it is tripped at 25°C.

CAUTION: Operation beyond the specified ratings may result in damage and possible arcing and flame.

Environmental Specifications

Test	Conditions							
Passive aging	+85°C, 1000 hrs.							
Humidity aging	+85°C, 85% R.H. , 1000 hrs.							
Thermal shock	+125°C to -55°C, 10 times							
Resistance to solvent	MIL-STD-202,Method 215F							
	MIL-STD-202,Method 201							
Ambient operating /storage conditions : - 40 °C to +85 °C								
Maximum surface temperature of the	Maximum surface temperature of the device in the tripped state is 125 °C							

Agency Approvals:



E201504(Alpha-Top)/E319079(Sea&Land)

Regulation/Standard:



2002/95/EC

HF

EN14582



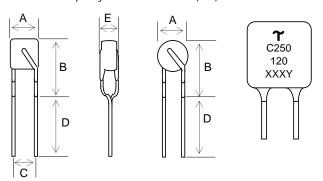
- · Use PPTC beyond the maximum ratings or improper use may result in device damage and possible electrical arcing and flame.
- · PPTC are intended for protection against occasional over current or over temperature fault conditions and should not be used when repeated fault conditions or prolonged trip events are anticipated.
- Device performance can be impacted negatively if devices are handled in a manner inconsistent with recommended electronic, thermal, and mechanical procedures for electronic components.
- · Use PPTC with a large inductance in circuit will generate a circuit voltage (L di/dt) above the rated voltage of the PPTC.
- · Avoid impact PPTC device its thermal expansion like placed under pressure or installed in limited space.

Physical Dimensions (Unit: mm)

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Model	Α	В	С	D	E	
Model	Max.	Max.	Тур.	Min.	Max.	
C250-080	6.5	12.0	5.1	5.0	3.8	
C250-110	6.5	15.0	5.1	5.0	3.8	
C250-120	7.0	15.0	5.1	5.0	3.8	
C250-145	7.0	13.5	5.1	5.0	3.8	
C250-180	10.5	16.5	5.1	5.0	3.8	

Dimensions Marking

Note: Round chip only used for C250 -080(T/U) and -110U



Physical Characteristics

Lead Material:

C250- 080~180: Tin-plated copper, 22AWG, $\,\Phi\,0.65\text{mm}(0.026\text{ in}).$

Lead Solderability: MIL-STD-202, Method 208E

I_{hold} Versus Temperature

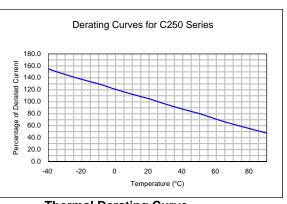
Model	Maximum ambient operating temperature (T _{mao}) vs. hold current (I _{hold})									
Model	-40°C	-20°C	0°C	25°C	40°C	50°C	60°C	70°C	85°C	
C250-080	0.124	0.110	0.095	0.080	0.066	0.059	0.051	0.044	0.033	
C250-110	0.171	0.151	0.131	0.110	0.091	0.081	0.071	0.061	0.046	
C250-120	0.186	0.165	0.143	0.120	0.099	0.088	0.077	0.066	0.050	
C250-145	0.225	0.199	0.172	0.145	0.119	0.106	0.093	0.080	0.060	
C250-180	0.279	0.247	0.213	0.180	0.147	0.131	0.115	0.099	0.074	

Order Information Packing

C250	120	T	RA	B-0.5	KR or KU	Reel Q'ty Bag	g Q'ty
Product	Hold	T= Pre-tripped	Rx=	B-x.x=	K=Kink leads		
name	Current	U= Uncoated	Resistance	Resistance Bin	R=Tape&Reel		
250V	(mA)	Blank= Standard	range	Range within 0.5ohm	U=Bulk package	1500 5	00
			(Optional)	in one lot. (Optional)			
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Devices taped with reference to EIA468-B standard.

Typical Time-To-Trip at 25°C



Thermal Derating Curve

